

### **CRYSTAL OSCILLATOR (SPXO)**

**OUTPUT: HCSL** 





Product Number SG2016HHN: X1G006231xxxx15 SG2520HHN: X1G005931xxxx15

### **SG2016HHN / SG2520HHN**

•Frequency range : 25 MHz to 500 MHz •Supply voltage : 2.5 V Typ. / 3.3 V Typ.

•Frequency tolerance :  $\pm 20 \times 10^{-6}$ 

•PCle Gen5,6 Jitter specification compliant

•Operating temperature : -40 °C to +85 °C, -40 °C to +105 °C •Function : Output enable (OE) or Standby  $(\overline{ST})$ 

•Phase jitter : 90 fs Max. (100 MHz < fo  $\leq$  156 MHz,  $V_{CC}$  = 2.5 V, 3.3 V)

SG2016HHN (2.0 × 1.6 × 0.63 mm)



SG2520HHN (2.5 × 2.0 × 0.74 mm)

### Specifications (characteristics)

Item	Symbol	Specifications	Condition	Conditions / Remarks	
Output frequency range	fo	25 MHz to 500 MHz	Please contact us for availa	Please contact us for available frequencies.	
Supply voltage	Vcc	D: 2.5 V ± 5 %, C: 3.3 V ± 5 %			
Storage temperature range	T_stg	-55 °C to +125 °C			
Operating temperature range	T_use	G: -40 °C to +85 °C, H: -40 °C to +105 °C			
Frequency tolerance	f_tol	C: ±20 × 10 <sup>-6</sup> Max.	temperature characteristics	Includes initial frequency tolerance, frequency / temperature characteristics, frequency / voltage coefficient and 10 years aging (+25 °C)	
Current consumption		35 mA Max.	25 MHz ≤ fo < 212 MHz	OE or $\overline{ST} = V_{CC}$ ,	
	Icc	40 mA Max.	212 MHz ≤ fo < 500 MHz	L_HCSL = $50 \Omega$	
Disable current	I_dis	25 mA Max.	OE = GND		
Stand-by current	1 -4-1	30 μA Max.	ST = GND, T_use Max. = +	ST = GND, T_use Max. = +85 °C	
	I_std	60 μA Max.	ST = GND, T_use Max. = +	·105 °C	
Symmetry	SYM	45 % to 55 %	At output crossing point	At output crossing point	
Output voltage		0.5 V to 0.7 V	25 MHz ≤ fo < 212 MHz	Output option: A	
	V <sub>OH</sub>	0.4 V to 0.65 V	212 MHz ≤ fo < 500 MHz		
		0.6 V to 0.8 V	25 MHz ≤ fo < 212 MHz	Output option: B	
		0.5 V to 0.75 V	212 MHz ≤ fo < 500 MHz		
	VoL	-0.15 V to +0.15 V			
Differential swing		0.7 V to 1.4 V	Output option: A	Output option: A	
	Vsw	0.8 V to 1.6 V		Output option: B	
Crossing voltage	V <sub>CR</sub>	0.25 V to 0.55 V			
Rise time / Fall time	tr/tf	0.7 ns Max.	20 % - 80 % (V <sub>OH</sub> - V <sub>OL</sub> )		
Differential output rise slew rate / fall slew rate	Rr/Rf	2 V/ns to 10 V/ns	Between -0.15 V and 0.15 V of differential output		
Output load condition	L_HCSL	50 Ω			
Input voltage	V <sub>IH</sub>	70 % V <sub>CC</sub> Min.	OE or ST terminal		
	V <sub>IL</sub>	30 % V <sub>CC</sub> Max.			
Output enable time	tsta_oe	500 ns Max.	t = 0 at OE = 70 % V <sub>CC</sub>		
	tsta_st	10 ms Max.	t = 0 at <del>ST</del> = 70 % V <sub>CC</sub>	t = 0 at <del>ST</del> = 70 % V <sub>CC</sub>	
Output disable time	tstp_oe	100 ns Max.	t = 0 at OE = 30 % V <sub>CC</sub>	t = 0 at OE = 30 % V <sub>CC</sub>	
	tstp_st	100 ns Max.	t = 0 at <del>ST</del> = 30 % V <sub>CC</sub>	t = 0 at <del>ST</del> = 30 % V <sub>CC</sub>	
Start-up time	t str	10 ms Max.	t = 0 at 90 % V <sub>CC</sub>	t = 0 at 90 % V <sub>CC</sub>	
Phase jitter	_	200 fs Max.	25 MHz ≤ fo < 100 MHz	Offset frequency	
		90 fs Max.	100 MHz ≤ fo ≤ 156 MHz	fo < 50 MHz:	
	tpJ	70 fs Max.	156 MHz < fo ≤ 212 MHz	12 kHz to 5 MHz	
		60 fs Max.	212 MHz < fo ≤ 391 MHz	fo ≥ 50 MHz:	
		50 fs Max.	391 MHz < fo ≤ 500 MHz	12 kHz to 20 MHz	
Jitter	t <sub>c-c</sub>	60 ps Max.	Cycle to cycle jitter (Peak to	Cycle to cycle jitter (Peak to Peak)	
PCIe jitter limits		0.1 ps Max.	For PCIe Gen5	For PCIe Gen5	
for CC architecture	-	0.06 ps Max.	For PCIe Gen6		

#### Product name

Product Name (Standard form)

a: Model b: Output (H: HCSL) c: Frequency d: Supply voltage e: Frequency tolerance

 $f: Operating \ temperature \quad g: Function \quad h: Output \ disable \ type \ (Z: High \ impedance) \quad i: Output \ option$ 

d: Supply voltage
C 3.3 V Typ.
D 2.5 V Typ.

e: Freq. tolerance C ±20 × 10<sup>-6</sup> f: Operating temp.

G -40 °C to +85 °C

H -40 °C to +105 °C

g: Function
P OE
S ST

i: Output option

A | V<sub>SW</sub> = 0.7 V to 1.4 V

B | V<sub>SW</sub> = 0.8 V to 1.6 V

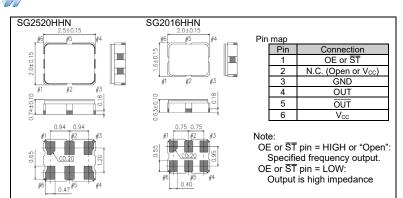
External dimensions

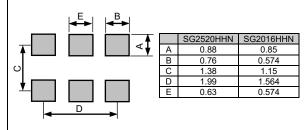
(Unit:mm

Footprint (Recommended)

(Unit:mm)

# Crystal oscillator





In order to achieve optimum jitter performance, it is recommended that 0.1  $\mu F$  and 10  $\mu F$  bypass capacitors should be connected between  $V_{\text{CC}}$  and GND and placed as close to the  $V_{\text{CC}}$  pin as possible.

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All of our major manufacturing and non-manufacturing sites, in Japan and overseas, completed the acquisition of ISO 14001 certification.

ISO 14000 is an international standard for environmental management that was established by the International Standards Organization in 1996 against the background of growing concern regarding global warming, destruction of the ozone layer, and global deforestation.

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IATF 16949 is the international standard that added the sector-specific supplemental requirements for automotive industry based on ISO9001.

Explanation of the mark that are using it for the catalog



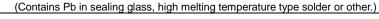
►Pb free.



► Complies with EU RoHS directive.

\*About the products without the Pb-free mark.

Contains Pb in products exempted by EU RoHS directive.





▶ Designed for automotive applications such as Car Multimedia, Body Electronics, Remote Keyless Entry etc.



▶ Designed for automotive applications related to driving safety (Engine Control Unit, Air Bag, ESC etc).

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